DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

### description

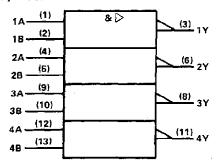
These devices contain four independent 2-input NAND buffer gates.

The SN5437, SN54LS37 and SN54S37 are characterized for operation over the full military range of  $-55\,^{\circ}\text{C}$  to  $125\,^{\circ}\text{C}$ . The SN7437, SN74LS37 and SN74S37 are characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ .

### FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	₿	Y
Н	Н	L
L	×	н
х	L	Н

### logic symbol†



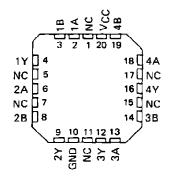
<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5437, SN54LS37, SN54S37... J OR W PACKAGE SN7437... N PACKAGE SN74LS37, SN74S37... D OR N PACKAGE (TOP VIEW)

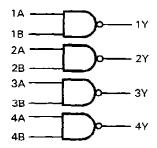
1A []1 1B []2 1Y []3	14 VCC 13 4B 12 4A
2A 🛮 4	11 47
2B 🗆 5	10∏ 3B
2Y 🗆 6 GND 🗆 7	9∏3A 8∐3Y

SN54LS37, SN54S37...FK PACKAGE (TOP VIEW)



NC - No internal connection

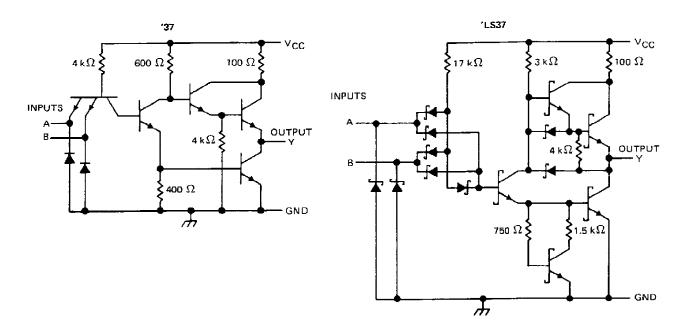
### logic diagram

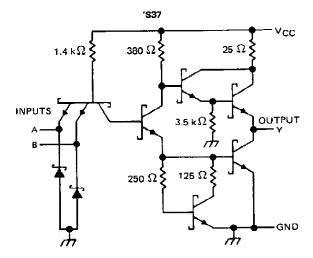


### positive logic

 $Y = \overline{A \cdot B}$  or  $Y = \overline{A} + \overline{B}$ 

### schematics (each gate)





Resistor values shown are nominal.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
Input voltage: '37, 'S37		5.5 V
1 S37		7 V
Operating free-air temperature: SI	N54'	. –55°C to 125°C
Si	N74'	0°C to 70°C
Storage temperature range		. –65°C to 1 <b>50</b> °C

NOTE 1: Voltage values are with respect to network ground terminal.



### recommended operating conditions

			SN5437	,	SN7437			UNIT
ļ		MIN	NOM	MAX	MIN	NOM	MAX	CIVIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage		-	8.0			0.8	V
ІОН	High-level output current			- 1.2			- 1.2	mΑ
loL	Low-level output current			48			48	mΑ
TA	Operating free-air temperature	- 55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN5437			SN7437		UNIT	
	LEST COMPLITIONS I			MIN	TYP#	MAX	MIN	TYP#	MAX	UNII
Vik	V <sub>CC</sub> ≈ MIN,	I <sub>I</sub> = - 12 mA				- 1.5			- 1.5	V
Voн	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V,	I <sub>OH</sub> = - 1.2 mA	2.4	3.3		2.4	3.3		V
VOL	V <sub>CC</sub> ≈ MIN,	V <sub>IH</sub> - 2 V,	IOL = 48 mA		0.2	0.4		0.2	0.4	V
T <sub>1</sub>	V <sub>CC</sub> ≈ MAX,	V <sub>1</sub> = 6.5 V				1			1	mA
ΊΗ	V <sub>CC</sub> = MAX,	V <sub> </sub> = 2.4 V				40			40	μА
ηլ	VCC = MAX,	V <sub>I</sub> = 0.4 V				- 1.6	T		- 1.6	mA
IOS §	V <sub>CC</sub> ≈ MAX			- 20		- 70	- 18		- 70	mA
Гссн	V <sub>CC</sub> ≈ MAX,	V <sub>1</sub> = 0 V			9	15.5	-	9	15.5	mΑ
ICCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			34	54		34	54	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	ТҮР	MAX	UNIT	
tpLH	A or B	~	B. = 122 O	C: - 45 pF	[	13	22	ns
†PHL	Aora	•	$R_{L}$ = 133 $\Omega$ ,	C <sub>L</sub> = 45 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{\Delta} = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

# SN54LS37, SN74LS37 QUADRUPLE 2-INPUT POSIT

### recommended operating condition

Vcc	Supply voltage
VIH	High-level input voltage
VIL	Low-level input voltage
Гон	High-level output current
loL	Low-level output current
TA	Operating free-air temperature

### electrical characteristics over reco

PARAMETER		TEST
VIK	V <sub>CC</sub> = MIN,	1 <sub>1</sub> = -
Voн	VCC = MIN,	V <sub>IL</sub> =
V	VCC = MIN,	V <sub>IH</sub> =
VoL	V <sub>CC</sub> = MIN,	V <sub>JH</sub> =
<u> </u>	V <sub>CC</sub> = MAX,	V <sub>J</sub> = 7
ΊΗ	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2
l <sub>IL</sub>	V <sub>CC</sub> = MAX.	V <sub>I</sub> = 0
1 <sub>OS</sub> §	V <sub>CC</sub> = MAX	
Іссн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0
IccL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4

 $\uparrow$  For conditions shown as MIN or MAX, use  $\ddagger$  All typical values are at  $\forall_{CC}$  = 5 V,  $T_A$  = 2 § Not more than one output should be short:

# switching characteristics, VCC = !

DAGAMETER	FROM	
PARAMETER	(INIDITY	in

### recommended operating conditions

		SN54S3	7	SN74S37		7	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC Supply voltage	4.5	5	5.5	4.75	- 5	5.25	V
VIH High-level input voltage	2			2			V
VIL Low-level input voltage			0.8			8.0	V
IOH High-level output current			<b>– 3</b>			- 3	mA
IOL Low-level output current			60			60	mA
TA Operating free-air temperature	- 55		125	0		70	°С

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54S3	7		SN74S3	7	UNIT	
		1E21 CONDIT	IONS :	MIN	түр‡	MAX	MIN	TYP ‡	MAX	UNII
VIK	VCC = MIN,	I <sub>1</sub> = - 18 mA			•	- 1.2			- 1.2	V
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V,	I <sub>OH</sub> = - 3 mA	2.5	3.4		2.7	3.4		
VoL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	IOL = 60 mA			0.5			0.5	V
11	VCC = MAX,	V <sub>I</sub> = 5.5 V	<u> </u>			1	Г		1	mA
Iн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				0.1	i		0.1	mA
III_	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.5 V			-	-4			- 4	mA
I <sub>OS</sub> §	V <sub>CC</sub> = MAX			50		- 225	- 50		- 225	mA
Гссн	V <sub>CC</sub> = MAX,	V1 - 0 V	•		20	36		20	36	mA
CCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5			46	80		46	80	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC}$  = 5 V,  $T_A$  =  $25^{\circ}$ C.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed 100 milliseconds.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN TYP	MAX	UNIT	
t <sub>PLH</sub>			B: = 93 C	C <sub>1</sub> = 50 pF	4	6.5	ns
tPHL	A or B	v	R <sub>L</sub> = 93 Ω,	OF 30 bi	4	6.5	ns
<sup>t</sup> PLH	700		P020	R <sub>L</sub> = 93 Ω, C <sub>L</sub> = 150 pF	6	•	กร
t <sub>PHL</sub>			HL = 93 12,		6		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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